

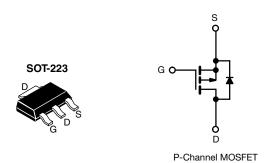
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Vishay Siliconix

HALOGEN

FREE

Power MOSFET



Marking code: FF

FEATURES

- Surface-mount
- Available in tape and reel
- Dynamic dv/dt rating
- · Repetitive avalanche rated
- P-channel
- Fast switching
- Ease of paralleling
- Material categorization: for definitions of compliance please see <u>www.vishav.com/doc?99912</u>

DESCRIPTION

Third generation power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The SOT-223 package is designed for surface-mount using vapor phase, infrared, or wave soldering techniques. Its unique package design allows for easy automatic pick-and-place as with other SOT or SOIC packages but has the added advantage of improved thermal performance due to an enlarged tab for heatsinking. Power dissipation of greater than 1.25 W is possible in a typical surface mount application.

ORDERING INFORMATION	
Package	SOT-223
Load (Dh) free and helegan free	SiHFL9110TR-GE3 a
Lead (Pb)-free and halogen-free	IRFL9110TRPbF-BE3 a, b
Lead (Pb)-free	IRFL9110TRPbF ^a

Notes

- a. See device orientation
- b. "-BE3" denotes alternate manufacturing location

ABSOLUTE MAXIMUM RATINGS (T _C	= 25 °C, unl	ess otherwis	se noted)			
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source voltage			V _{DS}	-100		
Gate-source voltage			V_{GS}	± 20	V	
Continuous drain current	\/ at 10.\/	$T_C = 25 ^{\circ}\text{C}$ $T_C = 100 ^{\circ}\text{C}$		-1.1		
Continuous drain current	V _{GS} at -10 V	T _C = 100 °C	Ι _D	-0.69	Α	
Pulsed drain current ^a			I _{DM}	-8.8		
Linear derating factor				0.025	W/°C	
Linear derating factor (PCB mount) e				0.017	7 W/C	
Single pulse avalanche energy b			E _{AS}	100	mJ	
Avalanche current ^a			I _{AR}	-1.1	Α	
Repetitive avalanche energy a			E _{AR}	0.31	mJ	
Maximum power dissipation	T _C = 25 °C		3.1		14/	
Maximum power dissipation (PCB mount) e	T _A = 25 °C		P_{D}	2.0	W	
Peak diode recovery dv/dt c			dv/dt	-5.5	V/ns	
Operating junction and storage temperature range			T _J , T _{stg}	-55 to +150	°C	
Soldering recommendations (peak temperature) d	For	10 s		300	7	

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)
- b. V_{DD} = -25 V, starting T_J = 25 °C, L = 7.7 mH, R_g = 25 Ω , I_{AS} = -4.4 A (see fig. 12)
- c. $I_{SD} \le$ -4.4 A, di/dt \le -75 A/ μ s, $V_{DD} \le$ V_{DS} , $T_J \le$ 150 °C
- d. 1.6 mm from case

S21-0322-Rev. G, 05-Apr-2021

e. When mounted on 1" square PCB (FR-4 or G-10 material)

1 Document Number: 91196



Vishay Siliconix

THERMAL RESISTANCE RAT	INGS				
PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT
Maximum junction-to-ambient (PCB mount) ^a	R _{thJA}	-	-	60	°C/W
Maximum junction-to-case (drain)	R _{thJC}	-	-	40	

Note

a. When mounted on 1" square PCB (FR-4 or G-10 material)

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static							•
Drain-source breakdown voltage	V_{DS}	V _{GS} =	$V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$		-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C, I _D = -1 mA	-	-0.091	-	V/°C
Gate-source threshold voltage	V _{GS(th)}	V _{DS} =	: V _{GS} , I _D = -250 μA	-2.0	-	-4.0	V
Gate-source leakage	I_{GSS}		V _{GS} = ± 20 V	-	-	± 100	nA
Zero gate voltage drain current	I _{DSS}		-100 V, V _{GS} = 0 V V, V _{GS} = 0 V, T _J = 125 °C	-	-	-100 - 500	μA
Drain-source on-state resistance	R _{DS(on)}		I _D = -0.66 A ^b	-	-	1.2	Ω
Forward transconductance	9 _{fs}		-50 V, I _D = -0.66 A	0.82	-		S
Dynamic							·
Input capacitance	C _{iss}	$V_{GS} = 0 \text{ V},$ $V_{DS} = -25 \text{ V},$ f = 1.0 MHz, see fig. 5		-	200	-	pF
Output capacitance	C _{oss}			-	94	-	
Reverse transfer capacitance	C _{rss}			-	18	-	
Total gate charge	Qg		I _D = -4.0 A, V _{DS} = -80 V, see fig. 6 and 13 ^b	-	-	8.7	nC
Gate-source charge	Q_{gs}	$V_{GS} = -10 \text{ V}$		-	-	2.2	
Gate-drain charge	Q_{gd}			-	-	4.1	
Turn-on delay time	t _{d(on)}	$V_{DD} = -50 \text{ V}, I_{D} = -4.0 \text{ A},$ $R_{g} = 24 \Omega, R_{D} = 11 \Omega, \text{ see fig. } 10^{\text{ b}}$		-	10	1	- ns
Rise time	t _r			-	27	-	
Turn-off delay time	$t_{d(off)}$			-	15	-	
Fall time	t _f]		17	-	
Internal drain inductance	L_D	Between lead, 6 mm (0.25") from package and center of die contact		-	4.0	ı	nH
Internal source inductance	L _S			-	6.0	-	11111
Drain-Source Body Diode Characteristic	cs						
Continuous source-drain diode current	Is	showing the			-	-1.1	A
Pulsed diode forward current ^a	I _{SM}	integral reverse p - n junction diode		-	-	-8.8	
Body diode voltage	V _{SD}	T _J = 25 °C,	, I _S = -1.1 A, V _{GS} = 0 V ^b	-		-5.5	V
Body diode reverse recovery time	t _{rr}	$T_J = 25 ^{\circ}\text{C}, I_F = -4.0 \text{A}, \text{dl/dt} = 100 \text{A/}\mu\text{s}^{\text{b}}$		-	80	160	ns
Body diode reverse recovery charge	Q _{rr}			-	0.15	0.30	μC
Forward turn-on time	t _{on}	Intrinsic tu	ırn-on time is negligible (turn	-on is do	minated b	y L _S and	L _D)

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)
- b. Pulse width \leq 300 µs; duty cycle \leq 2 %



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

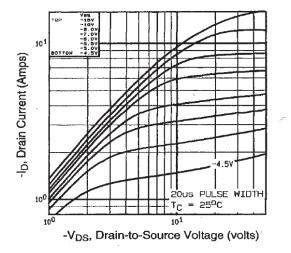


Fig. 1 - Typical Output Characteristics

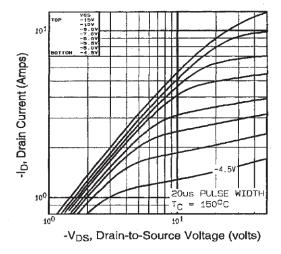


Fig. 2 - Typical Output Characteristics

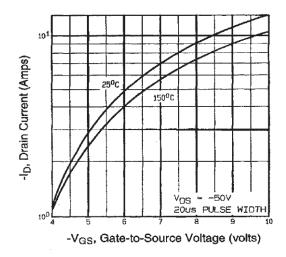


Fig. 3 - Typical Transfer Characteristics

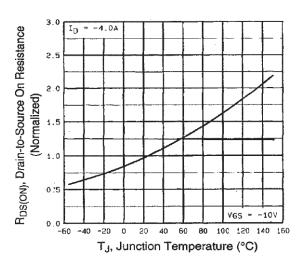


Fig. 4 - Normalized On-Resistance vs. Temperature



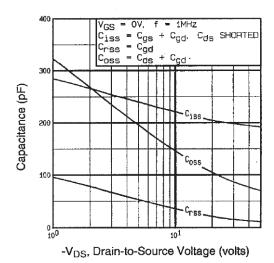


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

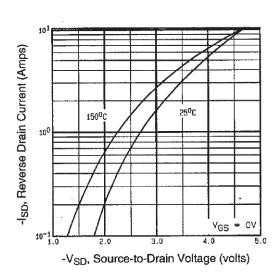


Fig. 7 - Typical Source-Drain Diode Forward Voltage

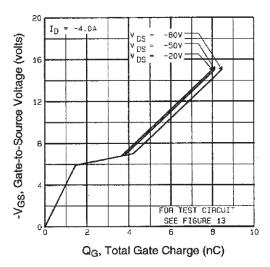


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

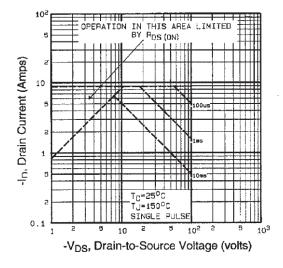


Fig. 8 - Maximum Safe Operating Area



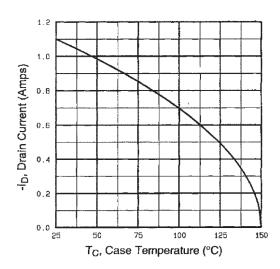


Fig. 9 - Maximum Drain Current vs. Case Temperature

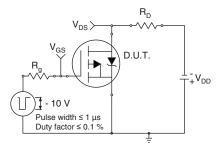


Fig. 10a - Switching Time Test Circuit

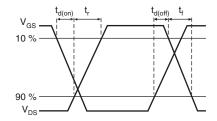


Fig. 10b - Switching Time Waveforms

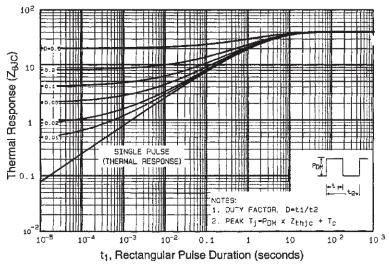


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case



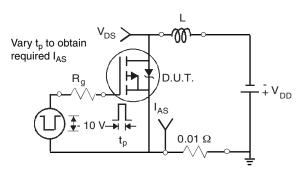


Fig. 12a - Unclamped Inductive Test Circuit

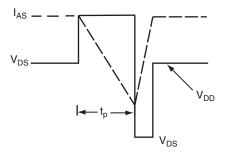


Fig. 12b - Unclamped Inductive Waveforms

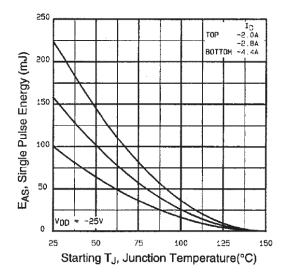


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

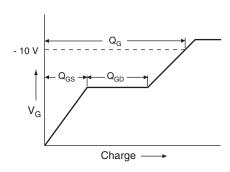


Fig. 13a - Basic Gate Charge Waveform

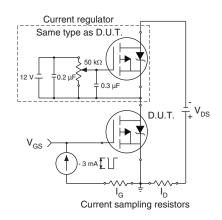
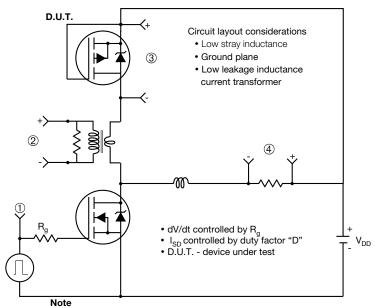


Fig. 13b - Gate Charge Test Circuit



Peak Diode Recovery dV/dt Test Circuit



• Compliment N-Channel of D.U.T. for driver

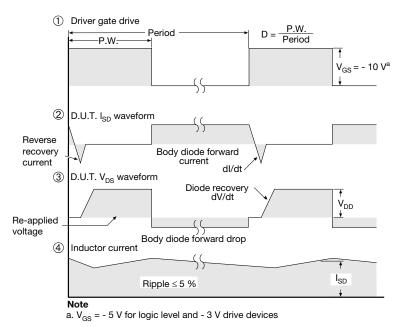


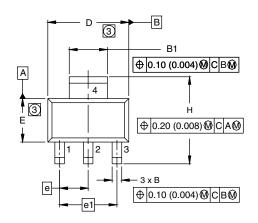
Fig. 14 - For P-Channel

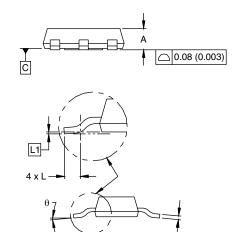
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Vishay Siliconix

SOT-223 (HIGH VOLTAGE)





DIM.	MILLI	METERS	INCHES		
	MIN.	MAX.	MIN.	MAX.	
Α	1.55	1.80	0.061	0.071	
В	0.65	0.85	0.026	0.033	
B1	2.95	3.15	0.116	0.124	
С	0.25	0.35	0.010	0.014	
D	6.30	6.70	0.248	0.264	
E	3.30	3.70	0.130	0.146	
е	2.30 BSC		0.0905	BSC	
e1	4.60 BSC		0.181	BSC	
Н	6.71	7.29	0.264	0.287	
L	0.91	-	0.036	=	
L1	0.061 BSC		0.0024	BSC	
θ	-	10'	-	10'	

ECN: S-82109-Rev. A, 15-Sep-08

DWG: 5969

Notes

- 1. Dimensioning and tolerancing per ASME Y14.5M-1994.
- 2. Dimensions are shown in millimeters (inches).
- 3. Dimension do not include mold flash.
- 4. Outline conforms to JEDEC outline TO-261AA.



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